

Confirmation of regulation GB 26572-2025 (China RoHS) and the associated information on Environmental Friendly Use Period (EFUP). This statement is valid for Hirschmann Automation and Control router, switches and accessories.

<p>产品中有害物质的名称及含有的信息表</p> <p>Table of names and information of hazardous substances contained in the product</p>										
<p>部件名称</p> <p>Component name</p>	<p>有害物质</p> <p>Hazardous substances</p>									
	<p>铅</p> <p>(Pb)</p> <p>Lead</p>	<p>汞</p> <p>(Hg)</p> <p>Mercury</p>	<p>镉</p> <p>(Cd)</p> <p>Cadmium</p>	<p>六价铬</p> <p>(Cr(VI))</p> <p>Hexavalent Chromium</p>	<p>多溴联苯</p> <p>(PBB)</p> <p>Polybrominated biphenyls</p>	<p>多溴二苯醚</p> <p>(PBDE)</p> <p>Polybrominated diphenyl ethers</p>	<p>邻苯二甲酸二正丁酯</p> <p>(DBP)</p> <p>Dibutylphthalate</p>	<p>邻苯二甲酸二异丁酯</p> <p>(DIBP)</p> <p>Diisobutylphthalate</p>	<p>邻苯二甲酸丁苯酯</p> <p>(BBP)</p> <p>Butylbenzylphthalate</p>	<p>邻苯二甲酸二(2-乙基)己酯</p> <p>(DEHP)</p> <p>Bis(2-ethylhexyl)phthalate</p>
<p>黄铜金属部件</p> <p>Metal components made of brass</p>	X	O	O	O	O	O	O	O	O	O
<p>PCBA 印刷电路板</p> <p>Printed circuit board assembly</p>	X	O	O	O	O	O	O	O	O	O
<p>注1: O: 表示该有害物质在该部件所有均质材料中的含量均低于 GB 26572-2025 规定的限量要求。</p> <p>Note1: Indicates that the hazardous substance listed is below the limits required by GB 26572-2025 in all homogeneous materials of this component.</p> <p>X: 表示该有害物质至少在该部件的某一均质材料中的含量超出 GB 26572-2025 规定的限量要求。</p> <p>Indicates that the hazardous substance listed exceeds the limits required by GB 26572-2025 in at least one of the homogeneous materials of this component.</p>										
<p>注2: 黄铜金属部件含铅量最高有可能达到4%, 然而, 这些零部件符合欧盟RoHS豁免条件。详情可参照欧盟指令2011/65/EU附录3中第6(c)项 { Annex III 6(c)}。</p> <p>Note2: Metal components made of brass may have a lead content of max. 4%; however, this complies with exceptional conditions of EU RoHS. Please refer to European Directive 2011/65/EU, Annex III 6(c) for details.</p> <p>注3: PCBA: 焊锡不含铅。PCBA板上的电子元件可能含铅。然而, 这些电子元件符合欧盟RoHS豁免条件。详情可参照欧盟指令2011/65/EU附录3中第7(c)-I项 { Annex III 7(c)-I}。</p> <p>Note3: Printed circuit board assembly: Solder is free of lead. Electronic components on PCBA may contain lead as listed in European Directive 2011/65/EU, Annex 7(c)-I. Please refer to European Directive 2011/65/EU, Annex III 7(c)-I for details.</p> <p>注4: 用于高熔点焊料的铅含量可达85% (按重量计), 这些零部件符合欧盟RoHS豁免条件。详情可参照欧盟指令2011/65/EU附录3中第7(a)项 { Annex III 7(a)}。</p> <p>Note4: Lead used in high melting temperature solders may contain up to 85%, by weight, however, this complies with exceptional conditions of EU RoHS. Please refer to European Directive 2011/65/EU, Annex III 7(a) for details.</p> <p>注5: 以上未列出的部件,表明其有害物质含量均低于 GB 26572-2025 规定的限量要求。</p> <p>Note5: The components not listed above indicate that the hazardous substance all below the limits required by GB 26572-2025.</p>										

这些产品的环保使用期为:

The Environment Friendly Use Period for these products is:

